

**REMARKS****Drawings**

In response to the objection that FIGS. 2-3, 5 and 7 are improperly cross hatched, applicant has amended these drawings with footprints 2 and medial traces 5 cross hatched.

In FIG. 1, R3', T3' is properly labeled for facilitating relevant description.

In FIG. 2, the reference line of numeral 14 is amended to be more accurate in accordance with the description of amended specification Paragraph [0019], lines 5-6: "An insulative layer 14 is sandwiched between every two of the insulated layers."

The above amendment is well supported by the specification and FIGS. 2-3, and thus believed to be acceptable.

**Specification**

The Examiner object the specification as failing to describe the routing of T3', R3', R3'', T3'' and C3'' in relation to figures and their respective connection with foot print T3 and R3. In response to this objection, applicant has amended original paragraph [0020] to describe the connection thereof more clearly. The amended description is well supported by FIGS. 1-3 and no new matter is introduced.

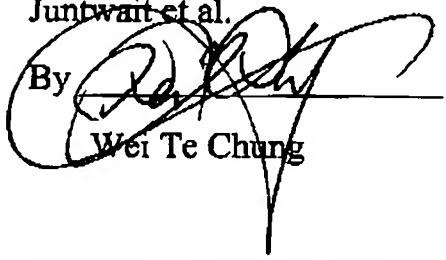
Applicant also corrected the "metalized hole 14" as "metalized hole 4" and some expression defects in paragraph [0019].

In view of the foregoing, the subject application is believed sufficient for further examination proceeding.

Respectfully submitted,

Juntwait et al.

By



Wei Te Chung

Registration No.: 43,325

Foxconn International, Inc.

P. O. Address: 1650 Memorex Drive, Santa Clara, CA 95050

Tel No.: (408) 919-6137